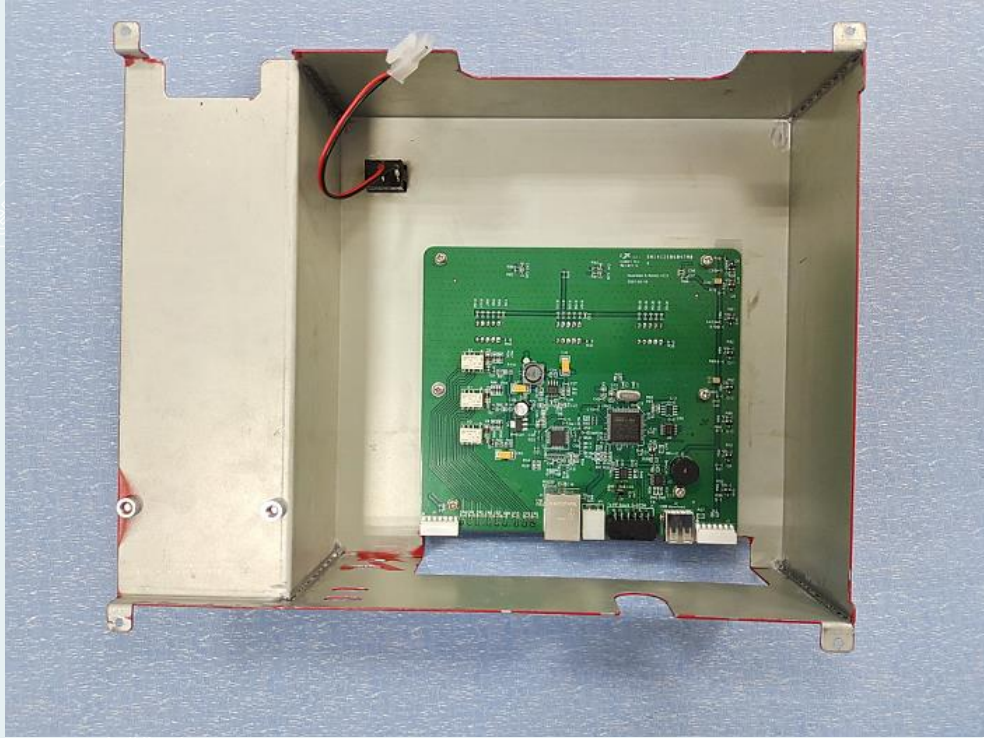
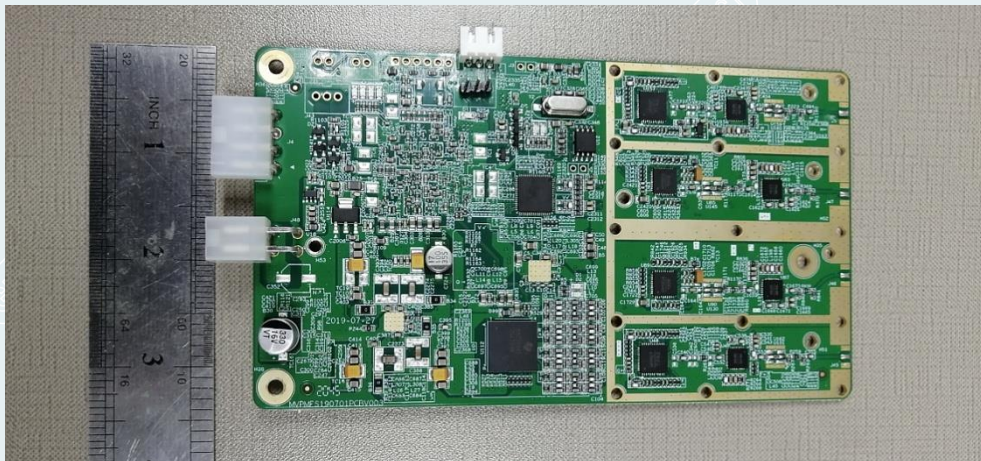


### B.2 Internal photos





DIF A and DIF B



DIF Board-A



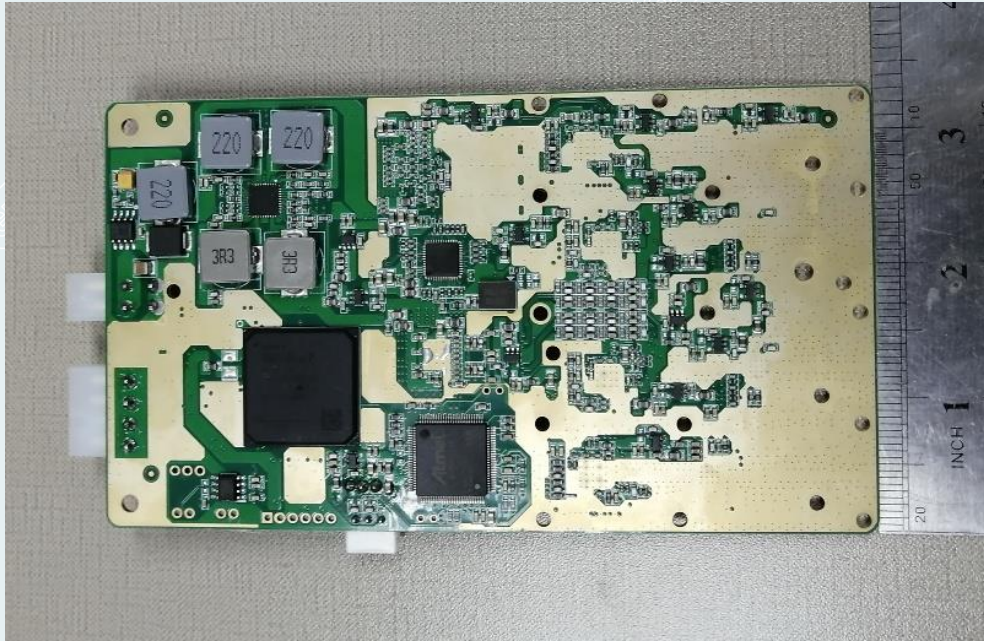


DIF Board-A



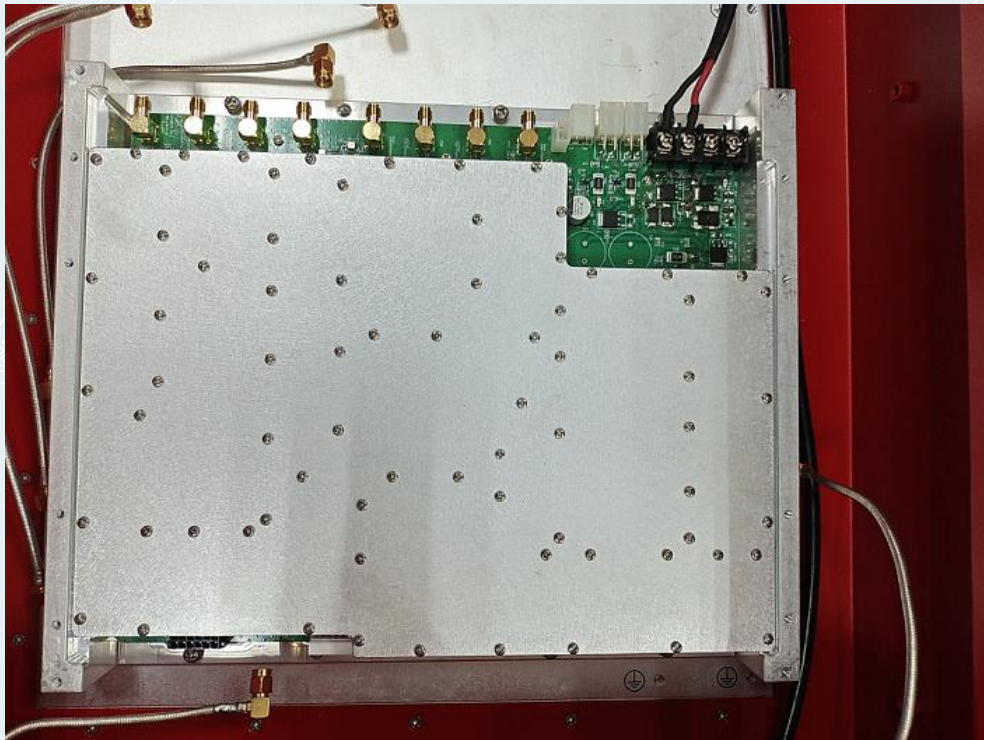
DIF Board-B

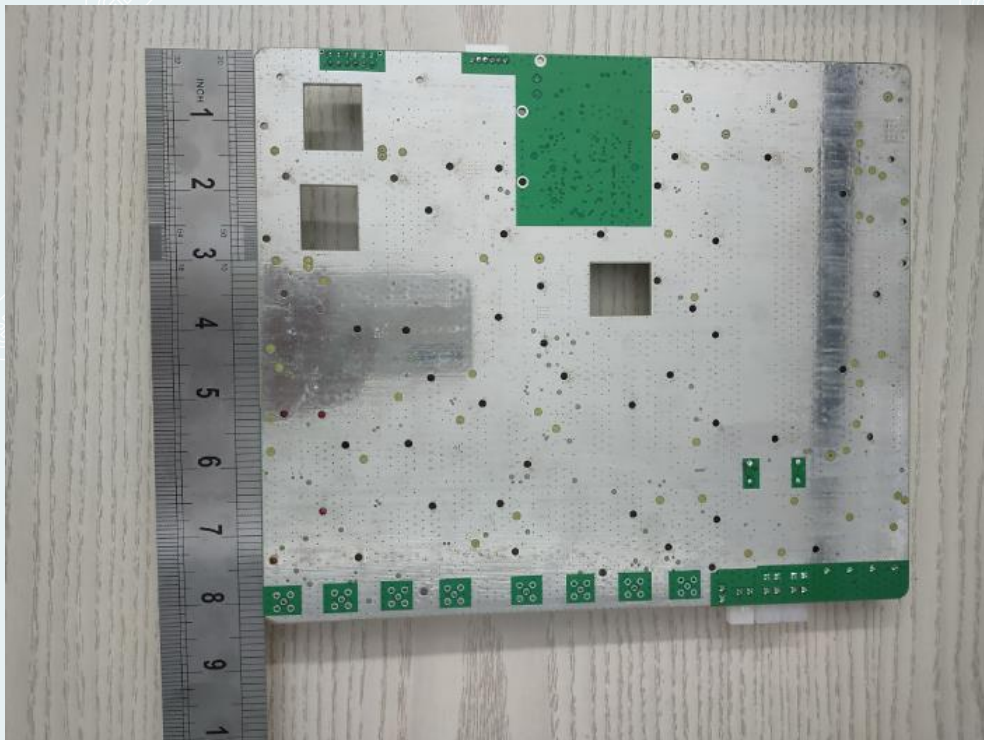
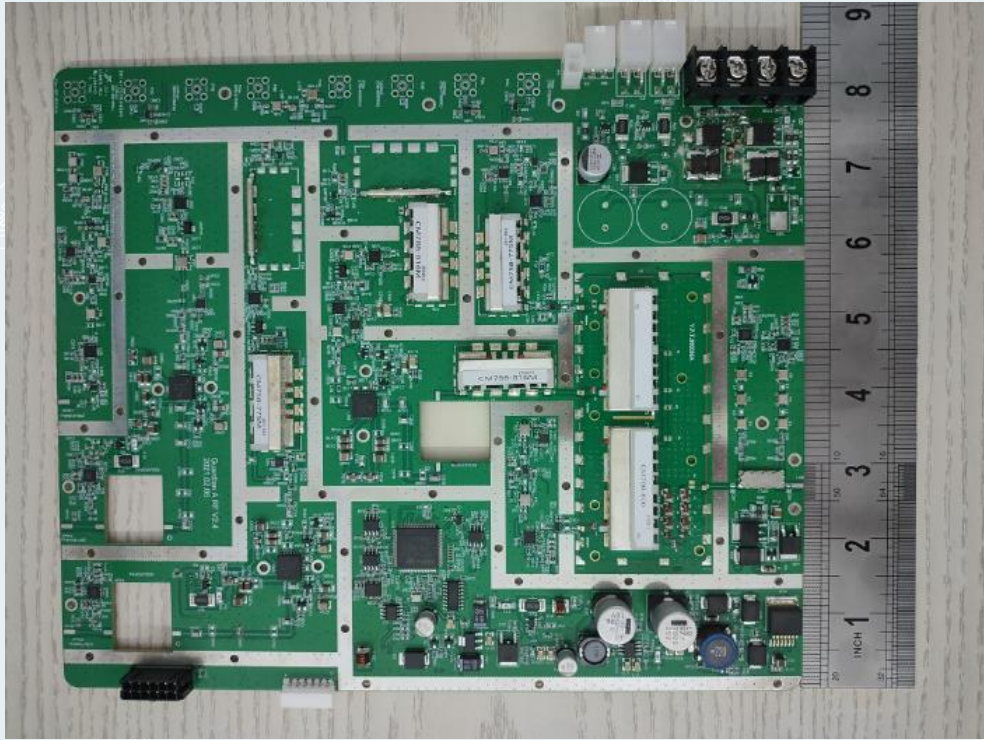




DIF Board-B

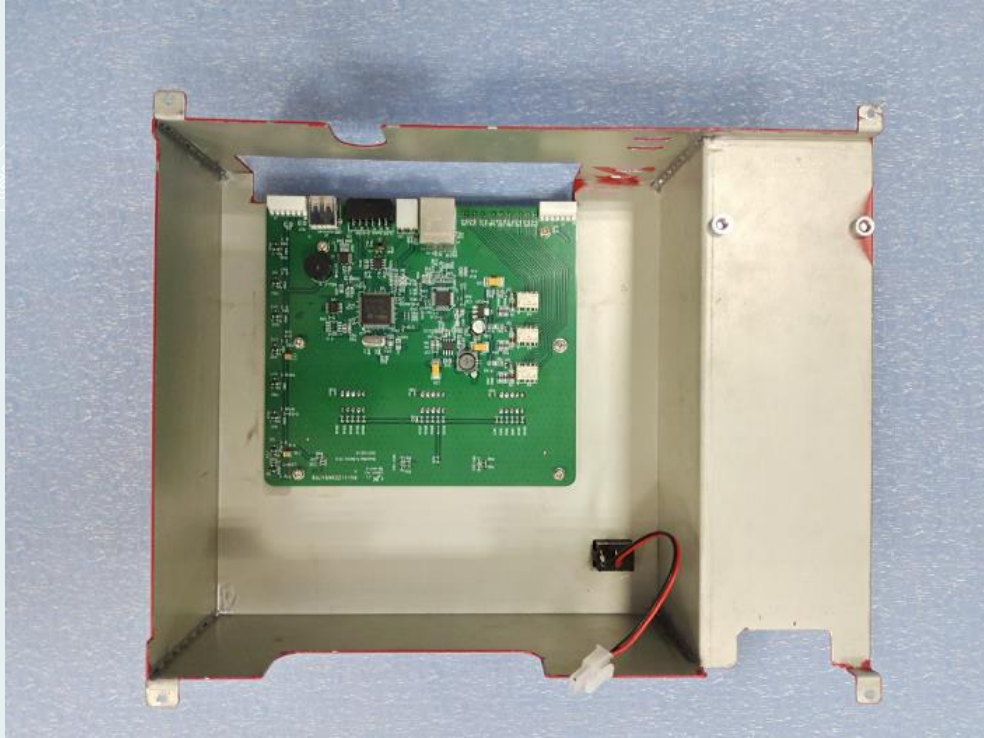
B.2.1 RF Board



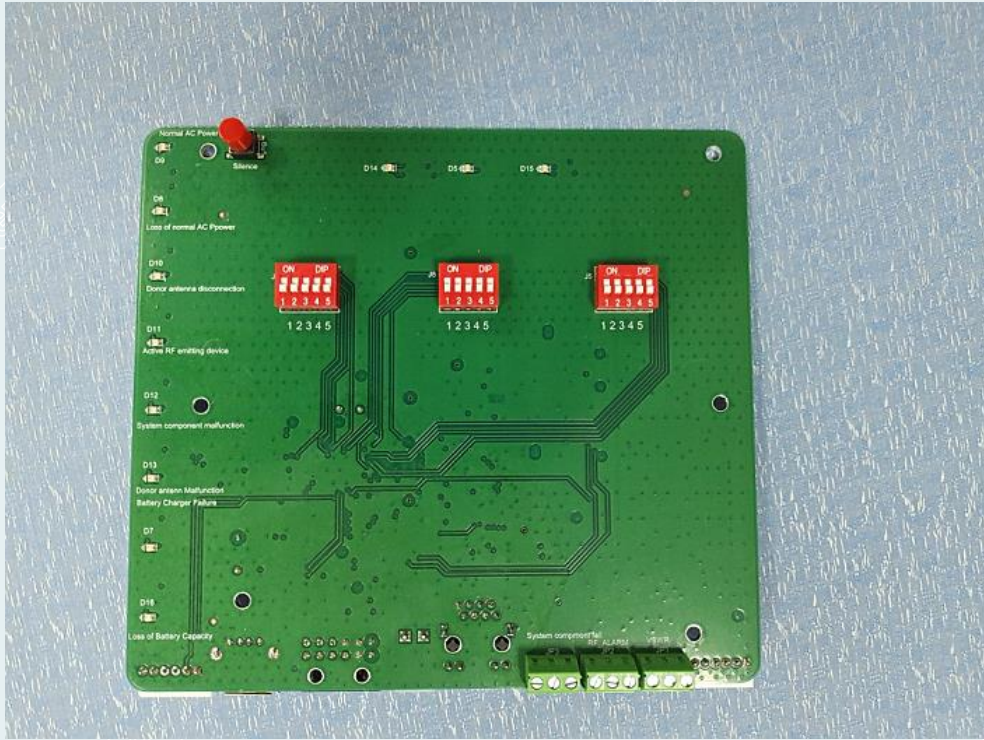




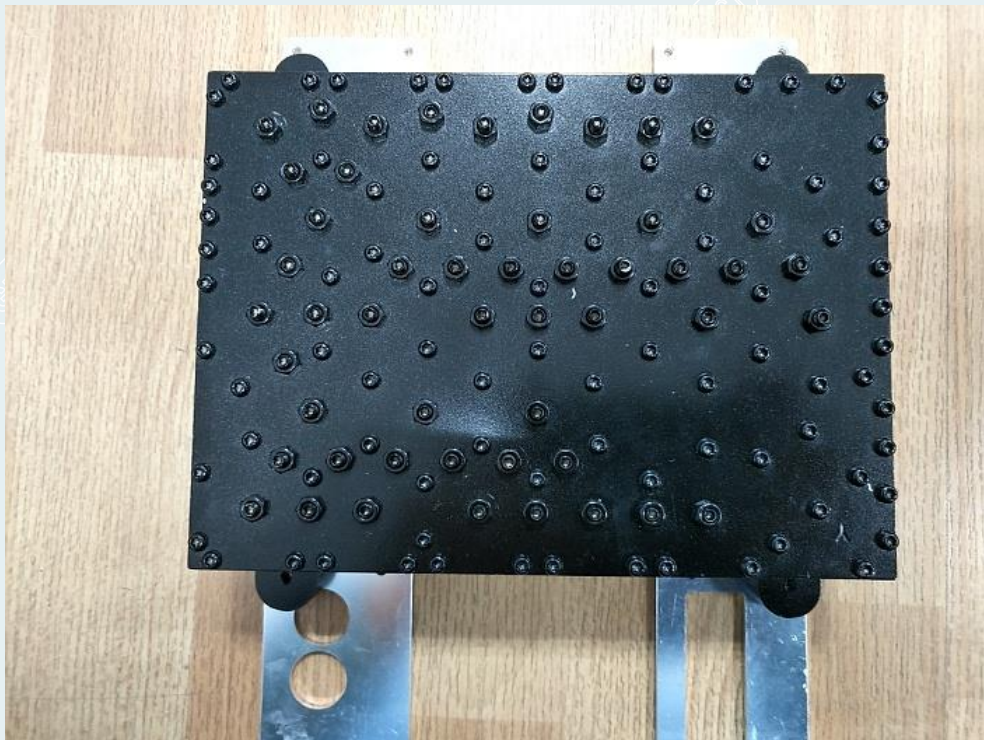
### B.2.2 Sentry Board



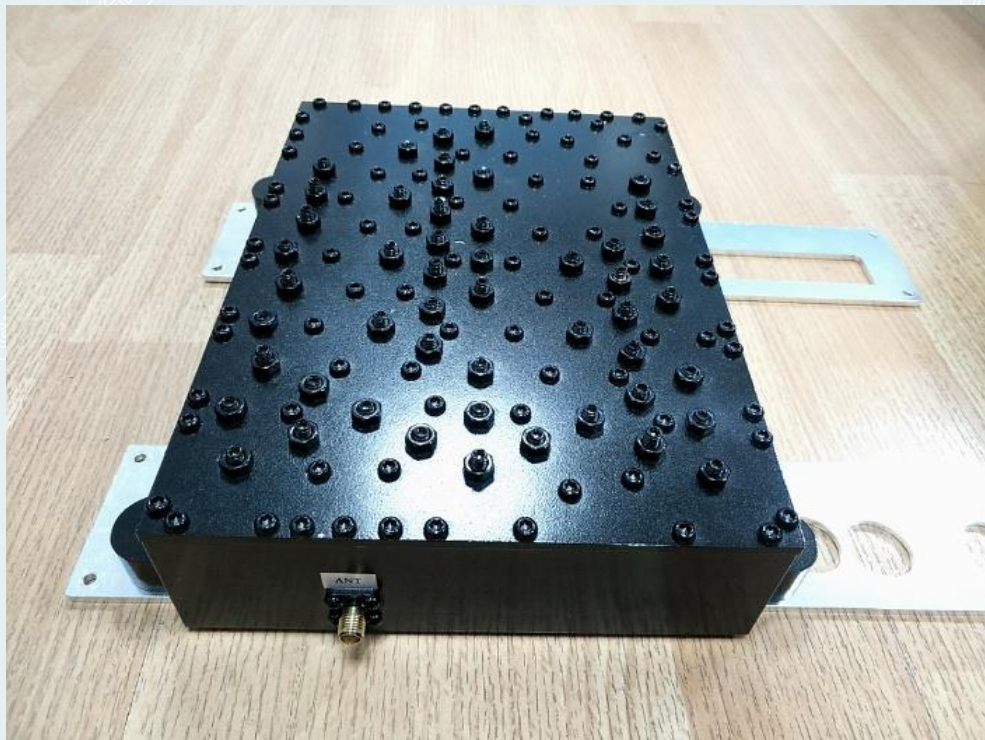




### B.2.3 Multiband combiner













### B.2.4 Power supply module











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